SPECIFICATION FOR LCD MODULE

Model No. <u>TM128160GKFWG</u>

Prepared by:	Date:
Checked by:	Date:
Verified by :	Date:
Approved by:	Date:

TIANMA MICROELECTRONICS CO., LTD

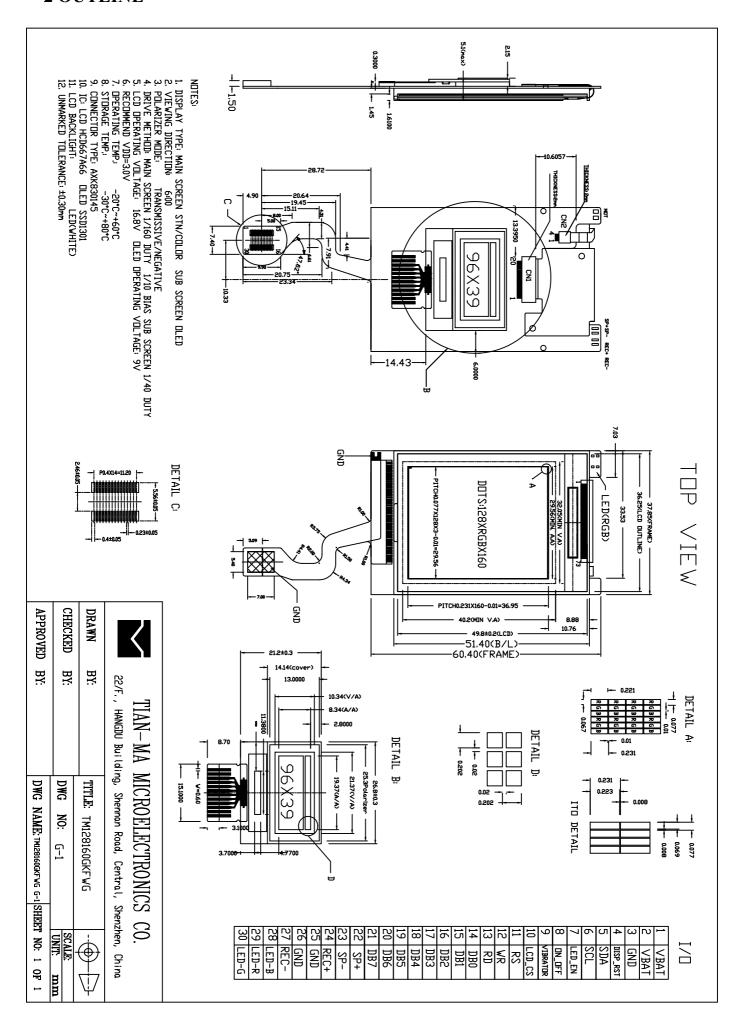
REVISION RECORD

Date	Ver.	Ref. Page	Revision No.	Revision Items

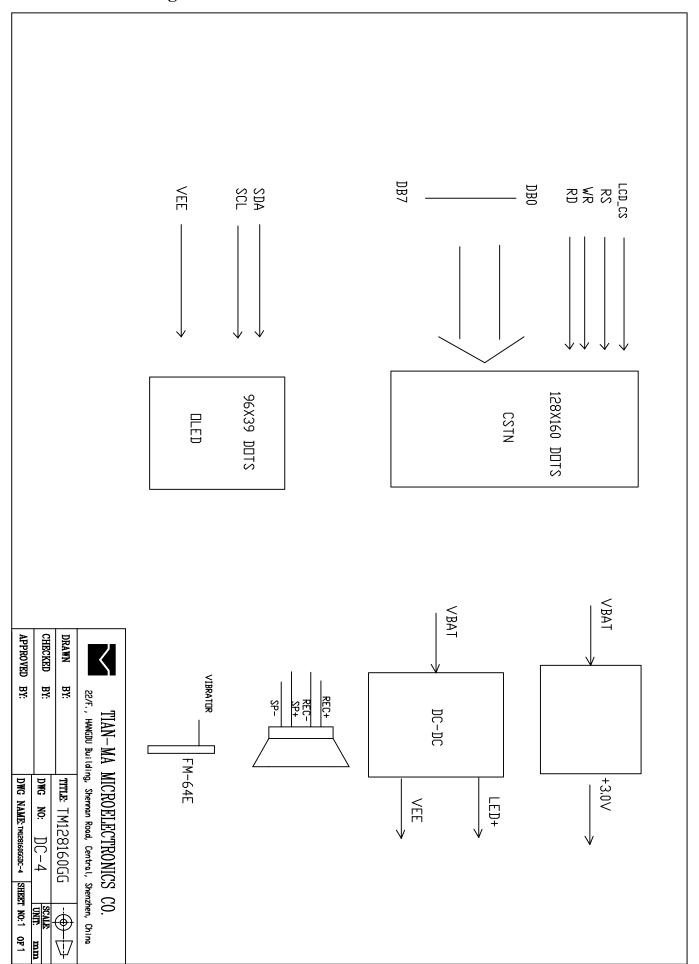
1 General Specifications:

ITEM	CONTEN	ΓS	UNIT
	MAIN LCD	SUB LCD	
LCD TYPE	COLOR STN	OLED	
LCD DUTY	1/160	1/40	
LCD BIAS	1/10		
VIEWING DIRECTION	6:00		O'CLOCK
GLASS AREA(WXH)	36.25X49.80	26.8X21.2	MM
VIEWING AREA(WXH)	32.05X40.20	21.374X10.338	MM
ACTIVE AREA(WXH)	29.56X36.95	19.374X8.338	MM
NUMBER OF DOTS	128(R+G+B)X160	96X32(B)+96X7(Y)	MM
DOTE SIZE(WXH)	0.221X0.221	0.182X0.182	MM
DOT PITCH(WXH)	0.231X0.231	0.202X0.202	MM
CONTROLLER	HD66766	SSD1301	
VBAT	3.6~4.5V(TYP)		
LCD OPERATING VOLTAGE	16.8	9	V
OUTLINE DIMENSIONS	REFER TO OUTI	INE DRAWING ON	
	NEXT PAGE		
BACKLIGHT	LED(WHITE)		
OPERATING TEMPERAT	-20+70	-20+60	
STORAGE TEMPERATURE	-30+80	-40+85	
WEIGHT	TBD		
DATA TRANSFER	8 BIT PARALLEL	I ² C	
POLARIZER MODE	TRANSMISSIVE		
	/NEGATIVE		

2 OUTLINE



3. Circuit Block Diagram



4 Absolute Maximum Ratings(Ta=25)

MAIN_LCD

Item	Symbol	Min.	Max.	Unit	Remark
Power Supply Voltage	VDD - VSS	-0.3	+4.6	V	
LCD Driving Voltage	VLCD	-0.3	+20.0	v	
Operating Temperature Range	ТОР	-20	+70		No
Storage Temperature Range	TST	-30	+80		Condensation

OLED

ITEM	MIN	MAX	UNIT	COMMENT
Supply Voltage (VDD)	-0.3	4	V	Ta=25
Supply Voltage (VEE)	0	VDD – 16.5	V	Ta=25
Input Voltage (Vin)	Vss - 0.3	Vdd + 0.3	V	Ta=25
Operating Temp.	-20	60		
Storage Temp	-40	85		

5. Electrical Specifications and Instruction Code (Vss=0v, Ta=25)

5.1 Electrical characteristics

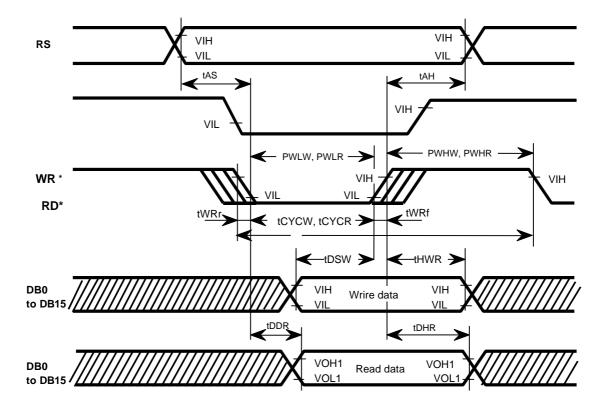
Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Supply voltage for logic	VBAT		3.2	3.8	12	V	
Supply voltage for main LCD (LCD DRIVE)	VLCD1			16.8		V	
Supply voltage for OLED (OLED DRIVE)	VLCD2			9		V	
Input voltage'H'	MAIN	VDD=3.0V	0.8VDD		VDD	V	
Level(V _{IH})	SUB	VDD=3.0V	0.8VDD		VDD	v	
Input voltage'L'	MAIN	VDD=3.0V	0		0.2VDD	V	
Level(V _{IL})	SUB	VDD=3.0V	0		0.2VDD	'	
Supply current	MAIN	VDD=3.0V			2.5	mA	
(Logic) I _{DD}	SUB	VDD=3.0V		0.5	1		
Supply Voltage (LED)	V_{LED}			9.9		V	
Supply current (LED)	I _{LED}			15.0	20.0	mA	

5.2 Interface Signals

PinNo.	Symbo 1	Level	Description
1	VBAT	Н	Power supply
2	VBAT	Н	Power supply
3	GND	L	GROUND
4	DISP—RST	H/L	Reset pin L: active
5	SDA	H/L	I ² c-BUS Data signal
6	SCL	H/L	I ² c-BUS Clock signal
7	LED-EN	H/L	Led enable pin L:active
8	ON-OFF	H/L	VDD on or off. H: active
9	VIBRATOR	H/L	VIBRATOR control pin.
10	LCD-CS	H/L	LCD Chip select pin
11	RS	H/L	Index select/Data command select
12	WR	H/L	Write operation(8080 system)
13	RD	H/L	Read operation(8080 system)
14	DB0	H/L	Data bus bit 0
15	DB1	H/L	Data bus bit 1
16	DB2	H/L	Data bus bit 2
17	DB3	H/L	Data bus bit 3
18	DB4	H/L	Data bus bit 4
19	DB5	H/L	Data bus bit 5
20	DB6	H/L	Data bus bit 6
21	DB7	H/L	Data bus bit 7
22	SP+	H/L	Speak input pin(+)
23	SP-	H/L	Speak input pin(-)
24	REC+	H/L	Receive input pin(+)
25	GND	L	GROUND
26	GND	L	GROUND
27	REC-	H/L	Receive input pin(-)
28	LED-B	H/L	Blue led control pin
29	LED-G	H/L	Green led control pin
30	LED-R	H/L	Red led control pin

5.3 Interface Timing Chart

HITACH HD66766 INTERFACE PROTOCOL



SOLOMON SSD1301 INTERFACE

MPU I²C Interface

The $lap{l}^2C$ communication interface consists of slave address bit SA0 (D_5), $lap{l}^2C$ -bus data signal SDA (D_0 for output and D_1 for input) and $lap{l}^2C$ -bus clock signal SCL (D_4). Both the data and clock signals must be connected to pull-up resistors. There are also five input signals including, RES#, CS1#, P/S#, CS2, SP#, which is used for the initialization of device.

a) Slave address bit (SA0)

SSD1301 has to recognize the slave address before transmitting or receiving any information by the l²C-bus. The device will respond to the slave address following by the slave address bit ("SA0" bit) and the read/write select bit ("R/W#" bit) with the following byte format,

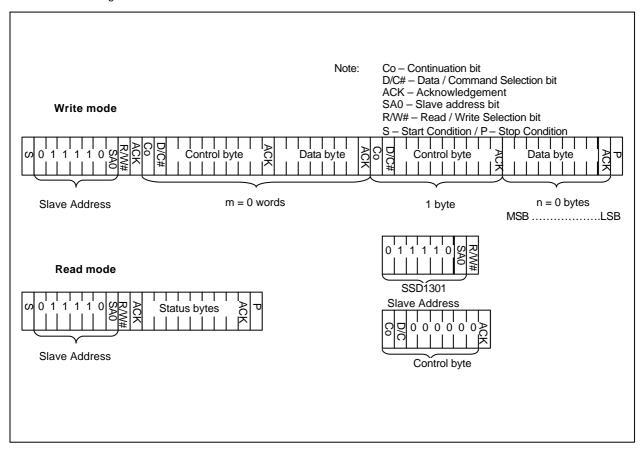
 $b_7 \ b_6 \ b_5 \ b_4 \ b_3 \ b_2 \ b_1 \ b_0$

0 1 1 1 1 0 SA0 R/W#

- "SA0" bit provides an extension bit for the slave address. Either "0111100" or "0111101", can be selected as the slave address of SSD1301.
- "R/W#" bit is used to determine the operation mode of the l²C-bus interface. R/W#=1, it is in read mode. R/W#=0, it is in write mode.
- b) I²C-bus data signal (SDA)
 - SDA acts as a communication channel between the transmitter and the receiver. The data and the acknowledgement are sent through the SDA. If SDA in is connected to the "SDA out", the device becomes fully PC bus compatible. It should be noticed that the ITO track resistance and the pulled-up resistance at "SDA" pin becomes a voltage potential divider. As a result, the acknowledgement would not be possible to attain a valid logic 0 level in "SDA". The "SDA out" pin may be disconnected from the "SDA in" pin. With such arrangement, the acknowledgement signal will be ignored in the PC-bus.
- c) I²C-bus clock signal (SCL)
 - The transmission of information in the l^2 C-bus is following a clock signal, SCL. Each transmission of data bit is taken place during a single clock period of SCL.

I²C-bus Write data and read register status

The $^{\circ}$ C-bus interface gives access to write data and command into the device. Please refer to Figure 8 for the write mode of $^{\circ}$ C-bus in chronological order.

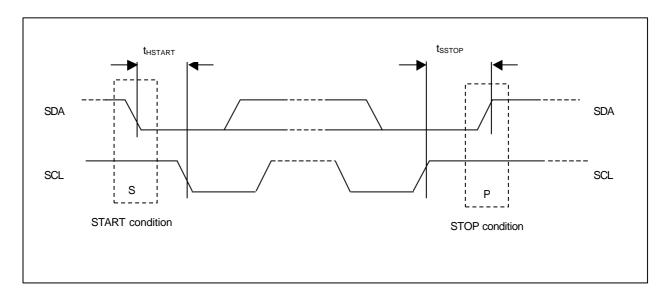


I²C-bus data format

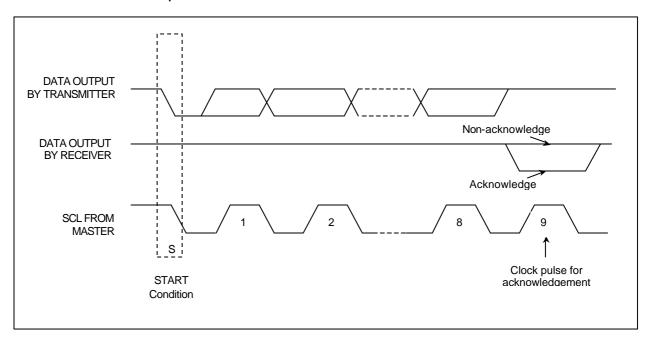
SOLOMON SSD1301 INTERFACE

Write mode for I2C

- The master device initiates the data communication by a start condition. The definition of the start condition is shown in Figure 9. The start condition is established by pulling the SDA from high to low while the SCL stays high.
- 2) The slave address is following the start condition for recognition use. For the SSD1301, the slave address is either "b0111100" or "b0111101" by changing the SA0 to high or low.
- 3) The write mode is established by setting the R/W# bit to logic "0"
- 4) An acknowledgement signal will be generated after receiving one byte of data, including the slave address and the R/W# bit. Please refer to the Figure 10 for the graphical representation of the acknowledge signal. The acknowledge bit is defined as the SDA line is pulled down during the high period of the acknowledgement related clock pulse.
- 5) After the transmission of the slave address, either the control byte or the data byte may be sent across the SDA. A control byte mainly consists of Co and D/C# bits following by six "0" 's.
 - a. If the Co bit is set as logic "0", the transmission of the following information will contain data bytes only.
 - b. The D/C# bit determines the next data byte is acted as a command or a data. If the D/C# bit is set to logic "0", it defines the following data byte as a command. If the D/C# bit is set to logic "1", it defines the following data byte as a data which will be stored at the GDDRAM. The GDDRAM column address pointer will be increased by one automatically after each data write.
- 6) Acknowledge bit will be generated after receiving each control byte or data byte.
- 7) The write mode will be finished when a stop condition is applied. The stop condition is also defined in Figure 9. The stop condition is established by pulling the "SDA in" from low to high while the "SCL" stays high.



Definition of the start and stop condition



Definition of the acknowledgement condition

5.4 Instruction code

Instruction List(HD66766)

				Upp	er Co	de						Low	er Co	de								
Reg. No.	Register Name	R/ W	RS	DB 15	DB 14	DB 13	DB 12	DB 11	DB 10	DB 9	DB 8	DB 7	DB 6	DB 5	DB 4	DB 3	DB 2	DB 1	DB 0	Description		
IR	Index	0	0	*	*	*	*	*	*	*	*	*	ID6	ID5	ID4	ID3	ID2	ID1	ID0	Sets the index register value.	0	Note1
SR	Status read	1	0	L7	L6	L5	L4	L3	L2	L1	L0	0	C6	C5	C4	C3	C2	Cl	C0	Reads the driving raster-row position (L7–0) and contrast setting (C6–0).	0	=
R00h	Start oscillation	0	1	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	1	Starts the oscillation mode.	10 ms	Note1
	Device code read	1	1	0	0	0	0	0	1	1	1	0	1	1	0	0	1	1	0	Reads 0766H.	0	="
R01h	Driver output control	0	1	0	0	0	0	0	0	CM S	SGS	0	0	0	NL4	NL3	NL2	NL1	NL0	Sets the common driver shift direction (CMS), segment driver shift direction (SGS) and driving duty ratio (NL4-0).	0	-
R02h	LCD- driving- waveform control	0	1	0	0	0	0	0	RST	B/C	EOR	0	0	NW 5	NW 4	NW 3	NW 2	NW 1	NW 0	Sets LCD drive AC waveform (B/C), and EOR output (EOR) or the number of n-raster-rows (NW5-0) at C-pattern AC drive.	0	=
R03h	Power control 1	0	1	BS3	BS2	BS1	BS0	BT3	BT2	BTI	вто	0	DC2	DC1	DC0	API	AP0	SLP	STB	Sets the sleep mode (SLP), standby mode (STB), LCD power on (API– 0), boosting cycle (DC2–0), boosting output multiplying factor (BT2–0), operation of voltage inverting circuit (BT3) and LCD drive bias value (BS3–0).	0	-
R04h	Contrast control	0	1	0	0	0	0	0	VR2	VR1	VR0	0	CT6	CT5	CT4	CT3	CT2	CT1	CT0	Sets the regulator adjustment (VR2–0) and contrast adjustment (CT6–0).	0	="
R05h	Entry mode	0	1	SPR	0	0	0	0	0	HWM	0	0	0	I/D1	I/D0	AM	LG2	LG1	LG0	Specifies AC counter mode (AM), increment/decrement mode (I/D1 – 0), high-speed write mode (HWM).	0	Note2
R06h	Compare Resister	0	1	CP1 5	CP1 4	CP1 3	CP1 2	CP1	CP1 0	CP9	CP8	CP7	CP6	CP5	CP4	CP3	CP2	CP1	CP0	Specifies the compare resister (CP15-0),	0	-
R07h	Display control	0	1	0	0	0	0	0	VLE2	VLE1	SPT	0	0	0	0	B/W	REV	DI	D0	Specifies display on (D1-0), black- and-white reversed display (REV), pixel on/off mode (ALB), screen division driving (SPT) and vertical scroll .(VLE2-1)	0	-
R0Bh	Frame frequency control	0	1	0	0	0	0	0	0	DIV 1	DIV 0	0	0	0	0	RTN 3	RTN 2	RTN 1	RTN 0	Specifies the line retrace period (RTN3-0) and operating clock frequency division ratio (DIV1-0).	0	-
R0Ch	Power control 2	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	VC2	VC1	VC0	Sets the adjustment factor for the Vci voltage (VC2-0).	0	="
R11h	Vertical scroll control	0	1	VL2 7	VL2 6	VL2 5	VL2 4	VL2 3	VL2 2	VL2 1	VL2 0	VL1 7	VL1 6	VL1 5	VL1 4	VL1 3	VL1 2	VL1	VL1 0	Sets the 1 st screen display start raster-row (VL17-10) and 2 nd screen display start raster-row (VL27-20).	0	=
R14h	1 st screen driving position	0	1	SE 17	SE 16	SE 15	SE 14	SE 13	SE 12	SE 11	SE 10	SS 17	SS 16	SS 15	SS 14	SS 13	SS 12	SS 11	SS 10	Sets the 1 st screen driving start position (SS17–10) and 1 st screen driving end position (SE17–10).	0	-
R15h	2 nd screen driving position	0	1	SE 27	SE 26	SE 25	SE 24	SE 23	SE 22	SE 21	SE 20	SS 27	SS 26	SS 25	SS 24	SS 23	SS 22	SS 21	SS 20	Sets 2 nd screen driving start position (SS27–20) and 2 nd screen driving end position (SE27–20).	0	-
R16h	Horizontal RAM address position	0	1	HE A7	HEA 6	HEA 5	HEA 4	HEA 3	HEA 2	HEA 1	HEA 0	HSA 7	HSA 6	HSA 5	HSA 4	HSA 3	HSA 2	HSA 1	HSA 0	Sets start (HSA7-0) and end (HEA7-0) of the horizontal RAM address range.	0	-
R17h	Vertical RAM address position	0	1	VEA	VEA 6	VEA 5	VEA 4	VEA 3	VEA 2	VEA 1	VEA 0	VSA 7	VSA 6	VSA 5	VSA 4	VSA 3	VSA 2	VSA 1	VSA 0	Sets start (VSA7-0) and end (VEA7-0) of the vertical RAM address range.	0	-
R20h	RAM write data mask	0	1	WM 15	WM 14	WM 13	WM 12	WM 11	WM 10	WM 9	WM 8	WM 7	WM 6	WM 5	WM 4	WM 3	WM 2	WM 1	WM 0	Specifies write data mask (WM15–0) at RAM write.	0	=
																						-

Instruction List (cont.)

Upper Code	Lower Code
• •	

Reg.	Register			DB	DB	DB	DB	DB	DB	DB	DB	DB	DB	DB	DB	DB	DB	DB	DB	-	Execu- tion
No.	Name	R/ W	RS	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Description	Cycle
R21h	RAM address set	0	1				AD15-	8 (upper)					ADo	5–0 (lov	/er)				Initially set the RAM address to the address counter (AC).	0
R22	RAM data write	0	1			V	Vrite da	ta (uppe	r)					1	Vrite da	ta (lowe	er)			Writes data to the RAM.	0
	RAM data read	1	1			F	Read dat	a (uppe	r)					1	Read da	ta (lowe	r)			Reads data from the RAM.	0
R30h	Grayscale palette control (1)	0	1	0	0	PK15	PK14	PK13	PK12	PK11	PK10	0	0	PK05	PK04	PK03	PK02	PK01	PK00	Specifies the grayscale palette.	0
R31h	Grayscale palette control (2)	0	1	0	0	PK35	PK34	PK33	PK32	PK31	PK30	0	0	PK25	PK24	PK23	PK22	PK21	PK20	Specifies the grayscale palette.	0
R32h	Grayscale palette control (3)	0	1	0	0	PK55	PK54	PK53	PK52	PK51	PK50	0	0	PK45	PK44	PK43	PK42	PK41	PK40	Specifies the grayscale palette.	0
R33h	Grayscale palette control (4)	0	1	0	0	PK75	PK74	PK73	PK72	PK71	PK70	0	0	PK65	PK64	PK63	PK62	PK61	PK60	Specifies the grayscale palette.	0
R34h	Grayscale palette control (5)	0	1	0	0	PK95	PK94	PK93	PK92	PK91	PK90	0	0	PK85	PK84	PK83	PK82	PK81	PK80	Specifies the grayscale palette.	0
R35h	Grayscale palette control (6)	0	1	0	0	PK 115	PK 114	PK 113	PK 112	PK 111	PK 110	0	0	PK 105	PK 104	PK 103	PK 102	PK 101	PK 100	Specifies the grayscale palette.	0
R36h	Grayscale palette control (7)	0	1	0	0	PK 135	PK 134	PK 133	PK 132	PK 131	PK 130	0	0	PK 125	PK 124	PK 123	PK 122	PK 121	PK 120	Specifies the grayscale palette.	0
R37h	Grayscale palette control (8)	0	1	0	0	PK 155	PK 154	PK 153	PK 152	PK 151	PK 150	0	0	PK 145	PK 144	PK 143	PK 142	PK 141	PK 140	Specifies the grayscale palette.	0
R38h	Grayscale palette control (9)	0	1	0	0	PK 175	PK 174	PK 173	PK 172	PK 171	PK 170	0	0	PK 165	PK 164	PK 163	PK 162	PK 161	PK 160	Specifies the grayscale palette.	0
R39h	Grayscale palette control (10)	0	1	0	0	PK 195	PK 194	PK 193	PK 192	PK 191	PK 190	0	0	PK 185	PK 184	PK 183	PK 182	PK 181	PK 180	Specifies the grayscale palette.	0
R3Ah	Grayscale palette control (11)	0	1	0	0	PK 215	PK 214	PK 213	PK 212	PK 211	PK 210	0	0	PK 205	PK 204	PK 203	PK 202	PK 201	PK 200	Specifies the grayscale palette.	0
R3Bh	Grayscale palette control (12)	0	1	0	0	PK 235	PK 234	PK 233	PK 232	PK 231	PK 230	0	0	PK 225	PK 224	PK 223	PK 222	PK 221	PK 220	Specifies the grayscale palette.	0
R3Ch	Grayscale palette control (13)	0	1	0	0	PK 255	PK 254	PK 253	PK 252	PK 251	PK 250	0	0	PK 255	PK 244	PK 243	PK 242	PK 241	PK 240	Specifies the grayscale palette.	0
R3Dh	Grayscale palette control (14)	0	1	0	0	PK 275	PK 274	PK 273	PK 272	PK 271	PK 270	0	0	PK 265	PK 264	PK 263	PK 262	PK 261	PK 260	Specifies the grayscale palette.	0
R3Eh	Grayscale palette control (15)	0	1	0	0	PK 295	PK 294	PK 293	PK 292	PK 291	PK 290	0	0	PK 285	PK 284	PK 283	PK 282	PK 281	PK 280	Specifies the grayscale palette.	0
R3Fh	Grayscale palette control (16)	0	1	0	0	PK 315	PK 314	PK 313	PK 312	PK 311	PK 310	0	0	PK 305	PK 304	PK 303	PK 302	PK 301	PK 300	Specifies the grayscale palette.	0

Note:

^{1. &}quot;*" means doesn't matter.

^{2.} High-speed write mode is available only for the RAM writing.

COMMAND TABLE (SSD1301)

Command table (D/C# =0, R/W#(WR#)=0, E (RD#)=1)

Bit Pattern	Command	Description							
0000X ₃ X ₂ X ₁ X ₀	Set Lower Column Address	Set the lower nibble of the column address register using $X_3X_2X_1X_0$ as data bits. The initial display line register is reset to 0000b after POR.							
0001X ₃ X ₂ X ₁ X ₀	Set Higher Column Address	Set the higher nibble of the column address register using $X_3X_2X_1X_0$ as data bits. The initial display line register is reset to 0000b after POR.							
01X ₅ X ₄ X ₃ X ₂ X ₁ X ₀	Set Display Start Line	Set display RAM display start line register from 063 using $X_5X_4X_3X_2X_1X_0$. Display start line register is reset to 000000 during POR.							
10000001 X ₇ X ₆ X ₅ X ₄ X ₃ X ₂ X ₁ X ₀	Set Contrast Control Register	Double byte command to select 1 out of 256 contrast steps. Contrast increases as $X_6X_5X_4X_3X_2X_1X_0$ is increased from 00000000b to 11111111b. $X_7X_6X_5X_4X_3X_2X_1X_0$ =10000000b after POR							
1010000X ₀	Set Segment Re-map	X ₀ =0: column address 00H is mapped to SEG0 (POR) X ₀ =1: column address 83H is mapped to SEG0							
1010010X ₀	Set Entire Display On/Off	X ₀ =0: normal display (POR) X ₀ =1: entire display on							
1010011X ₀	Set Normal/Inverse Display	X ₀ =0: normal display (POR) X ₀ =1: inverse display							
1010111X ₀	Set Display On/Off	X ₀ =0: turns off OLED panel (POR) X ₀ =1: turns on OLED panel							
1011X ₃ X ₂ X ₁ X ₀	Set Page Address	Set GDDRAM Page Address (0~8) for read/write using $X_3X_2X_1X_0$							
1100X ₃ * * *	Set COM Output Scan Direction	X ₃ =0: normal mode (POR) X ₃ =1: remapped mode. COM0 to COM[N-1] becomes COM[N-1] to COM0 in Multiplex ratio is equal to N.							
11100000	Set Read-Modify-Write Mode	Read-Modify-Write mode will be entered in which the column address will not be increased during display data read. After POR, Read-modify-write mode is turned OFF							
11100010	Software Reset	Initialize internal status registers							
11101110	Set End of Read-Modify-Write Mode	Exit Read-Modify-Write mode. RAM Column address before entering the mode will be restored. After POR, Read-modify-write mode is OFF.							
11100011	NOP	Command for No Operation							
1111 * * * *	Set Test Mode	Reserved for IC testing. Do NOT use.							
10101110 10100101	Set Sleep Mode	Sleep mode will be entered with two commands: Command 1: Turns off OLED panel Command 2: Set entire display on							

Bit Pattern	Command	Description
10101000	Set Multiplex Ratio	To select multiplex ratio N from 2 to the maximum multiplex ratio (POR value) (including icon line).
** $X_5X_4X_3X_2X_1X_0$		Max. mux ratio: 65
		$N= X_5 X_4 X_3 X_2 X_1 X_0 + 2$, e.g. $N=0011111b+2=17$
10101010 *10X ₄ X ₃ X ₂ X ₁ X ₀	Set Frame Frequency	Frame frequency is set by the following formula:
10101011 10X₅0X₃00X₀	Set Bias Current Mode	Set bias current level of segment output cell $X_5=0$ and $X_3=1$ and $X_0=0$: Normal (POR) $X_5=1$ and $X_3=0$ and $X_0=1$: Set low bias current level
1101000X ₀	Set Icon Mode	$X_0=0$: icon mode off (POR) $X_0=1$: icon mode on
11010011 **X ₅ X ₄ X ₃ X ₂ X ₁ X ₀	Set Display Offset	X ₅ X ₄ X ₃ X ₂ X ₁ X ₀ :000000=no scroll by row (POR) 111111=scroll by 63 rows
11011000 00000X ₂ 0X ₀	Set Low Power Display Mode	X_2 =0 and X_0 =0: Normal (POR) X_2 =1 and X_0 =1: Set low power consumption
11011001 X ₇ X ₆ X ₅ X ₄ X ₃ X ₂ X ₁ X ₀	Set Precharge Period	$\begin{split} X_7X_6X_5X_4: & \text{ Set precharge period (POR=1000)} \\ & [Invalid entry for $X_7X_6X_5X_4$=0001 or 0000] \\ X_3X_2X_1X_0=1000: & \text{Normal (POR)} \\ X_3X_2X_1X_0=0011: & \text{For low precharge period usage} \end{split}$
11011010 ***1**X ₁ 0	Set Current Mode	X ₁ =0: Select half range current mode (POR) X ₁ =1: Select full range current mode

Note: Remark "*" stands for "Don' t Care"

Read command table (D/C#=0, R/W#(WR#)=1, E(RD#)=1 for 6800 or E(RD#)=0 for 8080)

Bit Pattern	Command	Description
D ₇ D ₆ D ₅ D ₄ D ₃ D ₂ D ₁ D ₀	Status Register Read	D_7 =0: indicates the driver is ready for command. D_7 =1: indicates the driver is Busy. D_6 =0: indicates reverse segment mapping with column address D_6 =1: indicates normal segment mapping with column address D_5 =0: indicates the display is ON D_5 =1: indicates the display is OFF D_4 =0: initialization is not in progress D_4 =1: initialization is in progress after RES# or software reset

Note: Patterns other than that given in Command Table are prohibited to enter to the chip as a command; otherwise, unexpected result will occur.

6. Optical Characteristics

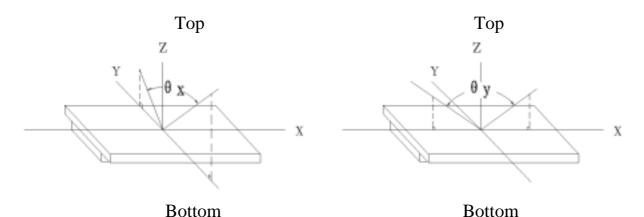
6.1 Optical Characteristics

V_{LCD}=16.8V Ta=25

of option characteristics							10.0 1	1 4 25	
Item		Symbol	Condition			Min.	Тур.	Max.	Unit
				y=0 °	MAIN	-	-40+35		
Viouvina	Anala	X	C > 2	y-0	SUB	_	-6036		
Viewing	Angle		Cr≥2	_x =0 °	MAIN	-	-30+30)	Deg
		у		x-0	SUB	_	-4240		
Contrast Ratio		Cr		x=0 ° $y=0$ °		30	50	60	ı
Response	Turn on	Ton		_x =0 °		-	-	150	ma
Time	Turn off	Toff		y=0 °		_	-	100	ms
	Red	X		x=0 °		-	0.43	-	ı
Color	Red	y	y=0 °	y=0 °		_	0.35	-	1
Of CIE Coord-	Green	X		_x =0 °		-	0.32	-	-
Inate	Olcell	у		y=0 °		_	0.46	-	-
	Plue	X		_x =0 °		_	0.22	-	_
	Blue	у		y=0 °		_	0.26	-	_

6.2 Definition of Optical Characteristics

6.2.1 Definition of Viewing Angle



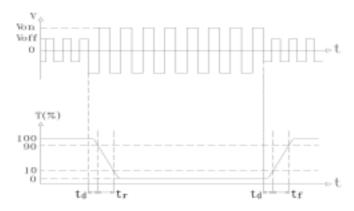
6.2.2 Definition of Contrast Ratio

Curve of selected segment Curve of unselected segment

Contrast Ratio = $B2/B1 = \frac{\text{unselected state brightness}}{\text{selected state brightness}}$

Measuring Conditions:

1) Ambient Temperature: 25 ; 2) Frame frequency: 70.0Hz 6.2.3 Definition of Response time



Turn on time: $t_{o\,n}=t_{\rm d}+t_{\rm r}$ Turn off time: $t_{o\,f\,f}=t_{\rm d}+t_{\rm f}$ Measuring Condition:

- 1) Operating Voltage:MAIN-LCD 16.8V SUB-LCD 9V
- 2) Frame frequency: 70.0Hz

6.3 Brightness Characteristic

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Brightness	Вр	Ta=25 ±3	100	-	-	cd/m ²
Uniformity	Вр	30-80%RH	-	-	60	%

Note:

- 1. The data is measured after LEDs are turned on for 5 minutes.
- 2. Testing conditions LED: V_{LED} = 270 V (AC) LCD: All dots are on (White color)
- 3. Brightness in the center of the LCD panel.
- 4. Definition of Uniformity (Bp)

Bp = Bp (Min.) / Bp (Max.) X 100 (%)

Bp (Max.) = Maximum brightness in 9 measurement spots

Bp (Min.) = Minimum brightness in 9 measurement spots

7. Reliability

7.1 Content of Reliability Test

Ta=25

No.	Test Item	Content of Test	Test condition		
1	High Temperature Storage	Endurance test applying the high storage temperature for a long time	80 ±2 240H Restore 4H at 25		
2	Low Temperature Storage	Endurance test applying the low storage temperature for a long time	-30 ±2 240H Restore 4H at 25		
3	High Temperature /Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time	70 ±2 90%RH 240H Restore 4H at 25		
4	Temperature Cycle	Endurance test applying the low and high temperature cycle -30			
		1 cycle	Restore 4H at 25		
5	Vibration Test (package state)	Endurance test applying the vibration during transportation	10Hz~150Hz, 100m/s², 120min		
6	Shock Test (package state)	Endurance test applying the shock during transportation	Half- sine wave, 300m/s ² , 18ms		
7	Atmospheric Pressure Test	Endurance test applying the atmospheric pressure during transportation by air	25kPa 16H Restore 2H		

7.2 Failure Judgment Criterion

Criterion		Test Item No.								Failure Indeement Criterian
Item	1	2	3	4	5	6	7	8	9	Failure Judgement Criterion
Basic Specification	√	V	1	1	V	V	√	√	√	Out of the basic Specification
Electrical specification	V	V	1	1	V					Out of the electrical specification
Mechanical Specification							V	V		Out of the mechanical specification
Optical Characteristic	1	V	1	1	V	V			√	Out of the optical specification
Note	For test item refer to 8.1									
Remark	Basic specification = Optical specification + Mechanical specification									

8. Quality Level

Examination	At T _a =25	Inspection				
or Test	(unless otherwise stated)	Min.	Max.	Unit	IL	AQL
External Visual Inspection	Under normal illumination and eyesight condition, the distance between eyes and LCD is 25cm.	See Appendix A			II	Major 1.0 Minor 2.5
Display Defects	Under normal illumination and eyesight condition, display on inspection.	See	e Append	lix B	II	Major 1.0 Minor 2.5

Note: Major defects: Open segment or common, Short, Serious damages, Leakage

Miner defects: Others

Sampling standard conforms to GB2828

9. Precautions for Use of LCD Modules

- 9.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
 - 9.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
 - 9.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
 - 9.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
 - 9.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 9.1.6 Do not attempt to disassemble the LCD Module.
- 9.1.7 If the logic circuit power is off, do not apply the input signals.
- 9.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

- 9.2 Storage precautions
- 9.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 9.2.2 The LCD modules should be stored under the storage temperature range.

 If the LCD modules will be stored for a long time, the recommend condition is:

Temperature: $0 \sim 40$

Relatively humidity: 80%

- 9.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 9.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

Appendix AInspection items and criteria for appearance defects

Items	Contents	Criteria					
Leakage		Not permitted	Not permitted				
Rainbow		According to	the lin	mit specimen			
	Wrong polarizer attachment	Not permitted	l				
Polarizer	Bubble between	Not counted		Max. 3 defects al	llowed		
	polarizer and glass	φ<0.3mm		0.3mm \$\phi\$ 0.51	nm		
	Scratches of polarizer	8 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1					
Black spot		Not counted	Max	Max. 3 spots allowed			
(in viewing area)	ا ا	X<0.2mm	0.2mm X 0.5mm Max.				
		X=(a+b)/2	spots (lines)				
Black line (in viewing		Not counted	Max	. 3 lines allowed	allowed		
area)	o	a<0.02mm	0.02mm a 0.05mm b 2.0mm				
Progressive cracks		Not permitted	l		,		

Appendix A

Inspection item and criteria for appearance defects (continued)

Items	Contents				Criteria		
	Cracks on pads	a	b	١	с	Max. 2 cracks allowed	
		3mm	V	V/5	T/2		
	b-4	2mm	V	V/5	T/2 <c<t< td=""><td></td></c<t<>		
	Cracks on contact side	a			b		
	/11/	3m	m		T/2		
		2m	2mm T/2 <b<t< td=""><td>Γ/2<b<t< td=""><td></td><td>M. 7</td></b<t<></td></b<t<>		Γ/2 <b<t< td=""><td></td><td>M. 7</td></b<t<>		M. 7
Glass		C shall be not reach the seal area				Max. 2 cracks	Max. 5 cracks allowed
Cracks	Cracks on non-contact side	a		b		allowed	
	d - G	3m	m	m T/2			
		2m	2mm		Γ/2 <b<t< td=""></b<t<>		
		C 0.5mm					
	2"	d SW/	d SW/3				
	Corner cracks	e<2.0mn				Max. 3	
	f-P	f<2.0mn	1 ²			cracks allowed	
	e-1/						

Appendix B
Inspection items and criteria for display defects

Items		Contents	Criteria				
Open segment or open common			Not permitted				
Short			Not permitted	ı			
Wrong view	ing angle		Not permitted	ı			
Contrast radi	o unevei	1	According to	the limit specimen			
Crosstalk			According to	the limit specimen			
		160	Not counted	Max.3 dots allowed			
	Ť [X<0.1mm	0.1mm X 0.2mm			
Pin holes	* <u> </u>		X=(a+b)/2	Max.3 dots			
and cracks in segment		Not counted	Max.2 dots allowed	allowed			
(DOT)			A<0.1mm	0.1mm A 0.2mm D<0.25mm			
Black spot	not		Not counted	Max.3 spots allowed			
(in viewing area)			X<0.1mm	0.1mm X 0.2mm			
	- a -	X=(a+b)/2	Spots				
Black line	D D		Not counted	Max.3 lines allowed	(lines) allowed		
(in viewing area)			a<0.02mm	0.02mm a 0.05mm b 0.5mm			

Appendix B
Inspection items and criteria for display defects (continued)

Items	Content	Criteria		
	10	Not counted	Max. 2 defects allowed	
		x < 0.1mm	0.1mm x 0.2mm	
		x=(a+b)/2		
	*			Max.3 defects
	D-711-a	Not counted	Max. 1 defects allowed	allowed
Transfor- mation of segment		a < 0.1mm	0.1mm a 0.2mm D>0	
		Max.2 defects 0.8W a 1.2		
	- W - a	a=measured va W=nominal va		